FEATURES
Single-supply voltage operation: 2.3 V to 5.5 V
Rail-to-rail common-mode input voltage range
Low input offset voltage across VCMR: 1 mV typical
Guarantees comparator output logic low from Vcc = 0.9 V to undervoltage lockout (UVLO)
Operating temperature range: −40°C to +125°C
Package types:
   8-lead, narrow body SOIC (ADCMP391/ADCMP392)
   14-lead, narrow body SOIC (ADCMP393)
   14-lead TSSOP (ADCMP393)

APPLICATIONS
Battery management/monitoring
Power supply detection
Window comparators
Threshold detectors/discriminators
Microprocessor systems

GENERAL DESCRIPTION
The ADCMP391/ADCMP392/ADCMP393 are single/dual/quad rail-to-rail input, low power comparators ideal for use in general-purpose applications. These comparators operate from a single supply voltage of 2.3 V to 5.5 V and draw a minimal amount of current. The single ADCMP391 consumes only 18.6 µA of supply current. The dual ADCMP392 and the quad ADCMP393 consumes 22.1 µA and 26.8 µA of supply current, respectively. The low voltage and low current operation of these devices makes it ideal for battery-powered systems.

The comparators features a common-mode input voltage range of 200 mV beyond rails, an offset voltage of 1 mV typical across the full common-mode range, and a UVLO monitor. In addition, the design of the comparators allows a defined output state upon power-up, a logic low output while the supply voltage is less than the UVLO threshold.

The ADCMP391 and ADCMP392 are available in 8-lead, narrow body SOIC package while the ADCMP393 is available in a 14-lead, narrow body SOIC package and a 14-lead TSSOP package. The comparators are specified to operate over the −40°C to +125°C extended temperature range.

FUNCTIONAL BLOCK DIAGRAMS

Figure 1.

Figure 2.

Figure 3.
# TABLE OF CONTENTS

- Features ............................................................................................................. 1
- Applications ......................................................................................................... 1
- General Description ............................................................................................ 1
- Functional Block Diagrams ............................................................................... 1
- Revision History .................................................................................................. 2
- Specifications ........................................................................................................ 3
- Absolute Maximum Ratings ................................................................................ 4
- Thermal Resistance ............................................................................................. 4
- ESD Caution .......................................................................................................... 4
- Pin Configurations and Function Descriptions ................................................. 5
- Typical Performance Characteristics ................................................................. 7
- Theory of Operation ............................................................................................ 10
  - Basic Comparator ............................................................................................. 10
  - Rail-to-Rail Input (RRI) .................................................................................. 10
- Open-Drain Output ............................................................................................... 10
- Power-Up Behavior .............................................................................................. 10
- Crossover Bias Point ............................................................................................ 10
- Comparator Hysteresis ......................................................................................... 10
- Typical Applications ............................................................................................ 11
  - Adding Hysteresis ............................................................................................ 11
  - Window Comparator for Positive Voltage Monitoring .............................. 11
  - Window Comparator for Negative Voltage Monitoring .......................... 12
  - Programmable Sequencing Control Circuit ............................................... 12
  - Mirrored Voltage Sequencer Example ......................................................... 14
  - Threshold and Timeout Programmable Voltage Supervisor ................. 15
- Outline Dimensions ............................................................................................. 16
- Ordering Guide .................................................................................................... 17
- Changes to Adding Hysteresis Section ............................................................. 11
- Changes to Figure 34 .......................................................................................... 13
- Added ADCMP391/ADCMP392 (Throughout) ............................................... 1
- Changes to Equation 4 ....................................................................................... 12
- Changes to Equation 13 and 15 ......................................................................... 13
- Changes to Ordering Guide ................................................................................ 18
- Added TSSOP Package (Throughout) ............................................................... 1
- Changes to Data Sheet Title ................................................................................. 1
- Added Figure 3; Renumbered Sequentially ....................................................... 5
- Changes to Open-Drain Output Section ............................................................ 9
- Changes to Programming Sequencing Control Circuit Section;  
  Added Figure 25; Changes to Figure 26 ............................................................. 11
- Changes to Figure 27 and Figure 28 ................................................................. 12
- Changes to Figure 29 .......................................................................................... 13
- Changes to Mirrored Voltage Sequencer Example Section ...................... 13
- Changes to Figure 30, and Figure 31 ................................................................. 14
- Added Figure 32, Outline Dimensions ............................................................. 15
- Changes to Ordering Guide ................................................................................. 15
- Changes to Product Title ................................................................................... 1
- Changes to Mirrored Voltage Sequencer Example Section ...................... 14
- Changes to Threshold and Timeout Programmable Voltage  
  Supervisor Section ............................................................................................... 14
- Changes to Title .................................................................................................. 1

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**5/14—Revision 0: Initial Version**

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**REVISION HISTORY**

4/16—Rev. C to Rev. D
- Changes to Adding Hysteresis Section ............................................................. 11
- Changes to Figure 34 .......................................................................................... 13

3/15—Rev. B to Rev. C
- Added ADCMP391/ADCMP392 (Throughout) ............................................... 1
- Changes to Equation 4 ....................................................................................... 12
- Changes to Equation 13 and 15 ......................................................................... 13
- Changes to Ordering Guide ................................................................................ 18

10/14—Rev. A to Rev. B
- Added TSSOP Package (Throughout) ............................................................... 1
- Changes to Data Sheet Title ................................................................................. 1
- Added Figure 3; Renumbered Sequentially ....................................................... 5
- Changes to Open-Drain Output Section ............................................................ 9

---

**6/14—Rev. 0 to Rev. A**
- Changes to Title .................................................................................................. 1
- Changes to Mirrored Voltage Sequencer Example Section ...................... 14
- Changes to Threshold and Timeout Programmable Voltage  
  Supervisor Section ............................................................................................... 14

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Note: The table of contents includes sections on features, applications, general description, functional block diagrams, revision history, specifications, absolute maximum ratings, thermal resistance, ESD caution, pin configurations, typical performance characteristics, theory of operation, and applications for adding hysteresis, window comparators for positive and negative voltage monitoring, programmable sequencing control circuit, mirrored voltage sequencer example, threshold and timeout programmable voltage supervisor, outline dimensions, and ordering guide.
**SPECIFICATIONS**

V\(_{CC}\) = 2.3 V to 5.5 V, T\(_A\) = −40°C to +125°C, V\(_{CMR}\) = −200 mV to V\(_{CC}\) + 200 mV, unless otherwise noted. Typical values are at T\(_A\) = 25°C.

<table>
<thead>
<tr>
<th>Table 1.</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>Parameter</strong></td>
</tr>
<tr>
<td>POWER SUPPLY</td>
</tr>
<tr>
<td>Supply Voltage</td>
</tr>
<tr>
<td>(V_{CC}) Quiescent Current</td>
</tr>
<tr>
<td>ADCMP391</td>
</tr>
<tr>
<td></td>
</tr>
<tr>
<td>ADCMP392</td>
</tr>
<tr>
<td></td>
</tr>
<tr>
<td>ADCMP393</td>
</tr>
<tr>
<td></td>
</tr>
<tr>
<td>UNDERVOLTAGE LOCKOUT</td>
</tr>
<tr>
<td>(V_{CC}) Rising UVLO</td>
</tr>
<tr>
<td>Hysteresis</td>
</tr>
<tr>
<td>COMPARATOR INPUT</td>
</tr>
<tr>
<td>Common-Mode Input Range</td>
</tr>
<tr>
<td>Input Offset Voltage</td>
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<tr>
<td></td>
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<tr>
<td></td>
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<tr>
<td></td>
</tr>
<tr>
<td>Input Offset Current</td>
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<tr>
<td>Input Bias Current</td>
</tr>
<tr>
<td></td>
</tr>
<tr>
<td></td>
</tr>
<tr>
<td>Input Hysteresis</td>
</tr>
<tr>
<td>COMPARATOR OUTPUT</td>
</tr>
<tr>
<td>Output Low Voltage</td>
</tr>
<tr>
<td></td>
</tr>
<tr>
<td>Output Leakage Current</td>
</tr>
<tr>
<td>COMPARATOR CHARACTERISTICS</td>
</tr>
<tr>
<td>Power Supply Rejection Ratio</td>
</tr>
<tr>
<td>Common-Mode Rejection Ratio</td>
</tr>
<tr>
<td>Voltage Gain</td>
</tr>
<tr>
<td>Rise Time(^2)</td>
</tr>
<tr>
<td>Fall Time(^2)</td>
</tr>
<tr>
<td>Propagation Delay</td>
</tr>
<tr>
<td>Input Rising(^2)</td>
</tr>
<tr>
<td></td>
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<tr>
<td></td>
</tr>
<tr>
<td></td>
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<tr>
<td>ADCMP392 Channel B</td>
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<tr>
<td></td>
</tr>
<tr>
<td></td>
</tr>
<tr>
<td>Input Falling(^2)</td>
</tr>
<tr>
<td></td>
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<td></td>
</tr>
<tr>
<td></td>
</tr>
<tr>
<td>ADCMP392 Channel B</td>
</tr>
<tr>
<td></td>
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<tr>
<td></td>
</tr>
</tbody>
</table>

\(^{1}\) \(V_{OD}\) = overdrive voltage.

\(^{2}\) \(R_{PULLUP} = 10\ k\Omega\), and \(C_{L} = 50\ \mu F\).
ABSOLUTE MAXIMUM RATINGS

Table 2.

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Rating</th>
</tr>
</thead>
<tbody>
<tr>
<td>VCC Pin</td>
<td>−0.3 V to +6 V</td>
</tr>
<tr>
<td>All INx+ and INx− Pins</td>
<td>−0.3 V to +6 V</td>
</tr>
<tr>
<td>All OUTx Pins</td>
<td>−0.3 V to +6 V</td>
</tr>
<tr>
<td>OUTx Pins Sink Current (IOUT)</td>
<td>10 mA</td>
</tr>
<tr>
<td>Storage Temperature Range</td>
<td>−65°C to +150°C</td>
</tr>
<tr>
<td>Operating Temperature Range</td>
<td>−40°C to +125°C</td>
</tr>
<tr>
<td>Lead Temperature (10 sec)</td>
<td>300°C</td>
</tr>
<tr>
<td>Junction Temperature</td>
<td>150°C</td>
</tr>
</tbody>
</table>

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

THERMAL RESISTANCE

Table 3. Thermal Resistance

<table>
<thead>
<tr>
<th>Package Type</th>
<th>θJA</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>8-Lead Narrow-Body SOIC</td>
<td>121</td>
<td>°C/W</td>
</tr>
<tr>
<td>14-Lead Narrow-Body SOIC</td>
<td>80</td>
<td>°C/W</td>
</tr>
<tr>
<td>14-Lead TSSOP</td>
<td>125</td>
<td>°C/W</td>
</tr>
</tbody>
</table>

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.
Table 4. ADCMP391 Pin Function Descriptions

<table>
<thead>
<tr>
<th>Pin No.</th>
<th>Mnemonic</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>1, 5, 8</td>
<td>NIC</td>
<td>Not Internally Connected</td>
</tr>
<tr>
<td>2</td>
<td>IN-</td>
<td>Comparator Inverting Input</td>
</tr>
<tr>
<td>3</td>
<td>IN+</td>
<td>Comparator Noninverting Input</td>
</tr>
<tr>
<td>4</td>
<td>GND</td>
<td>Device Ground</td>
</tr>
<tr>
<td>6</td>
<td>OUT</td>
<td>Comparator Output, Open-Drain</td>
</tr>
<tr>
<td>7</td>
<td>VCC</td>
<td>Device Supply Input</td>
</tr>
</tbody>
</table>

Table 5. ADCMP392 Pin Function Descriptions

<table>
<thead>
<tr>
<th>Pin No.</th>
<th>Mnemonic</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>OUTA</td>
<td>Comparator A Output, Open-Drain</td>
</tr>
<tr>
<td>2</td>
<td>INA−</td>
<td>Comparator A Inverting Input</td>
</tr>
<tr>
<td>3</td>
<td>INA+</td>
<td>Comparator A Noninverting Input</td>
</tr>
<tr>
<td>4</td>
<td>GND</td>
<td>Device Ground</td>
</tr>
<tr>
<td>5</td>
<td>INB+</td>
<td>Comparator B Noninverting Input</td>
</tr>
<tr>
<td>6</td>
<td>INB−</td>
<td>Comparator B Inverting Input</td>
</tr>
<tr>
<td>7</td>
<td>OUTB</td>
<td>Comparator B Output, Open-Drain</td>
</tr>
<tr>
<td>8</td>
<td>VCC</td>
<td>Device Supply Input</td>
</tr>
</tbody>
</table>
Table 6. ADCMP393 Pin Function Descriptions

<table>
<thead>
<tr>
<th>Pin No.</th>
<th>Mnemonic</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>OUTB</td>
<td>Comparator B Output, Open Drain</td>
</tr>
<tr>
<td>2</td>
<td>OUTA</td>
<td>Comparator A Output, Open Drain</td>
</tr>
<tr>
<td>3</td>
<td>VCC</td>
<td>Device Supply Input</td>
</tr>
<tr>
<td>4</td>
<td>INA−</td>
<td>Comparator A Inverting Input</td>
</tr>
<tr>
<td>5</td>
<td>INA+</td>
<td>Comparator A Noninverting Input</td>
</tr>
<tr>
<td>6</td>
<td>INB−</td>
<td>Comparator B Inverting Input</td>
</tr>
<tr>
<td>7</td>
<td>INB+</td>
<td>Comparator B Noninverting Input</td>
</tr>
<tr>
<td>8</td>
<td>INC−</td>
<td>Comparator C Inverting Input</td>
</tr>
<tr>
<td>9</td>
<td>INC+</td>
<td>Comparator C Noninverting Input</td>
</tr>
<tr>
<td>10</td>
<td>IND−</td>
<td>Comparator D Inverting Input</td>
</tr>
<tr>
<td>11</td>
<td>IND+</td>
<td>Comparator D Noninverting Input</td>
</tr>
<tr>
<td>12</td>
<td>GND</td>
<td>Device Ground</td>
</tr>
<tr>
<td>13</td>
<td>OUTD</td>
<td>Comparator D Output, Open Drain</td>
</tr>
<tr>
<td>14</td>
<td>OUTC</td>
<td>Comparator C Output, Open Drain</td>
</tr>
</tbody>
</table>
TYPICAL PERFORMANCE CHARACTERISTICS

Figure 8. Input Offset Voltage (V_{OS}) vs. Common-Mode Voltage (V_{CM}), V_{CC} = 3.3 V

Figure 9. Input Offset Voltage (V_{OS}) vs. Temperature for Various Supply Voltages (V_{CC}), V_{CM} = 1 V

Figure 10. Supply Current vs. Supply Voltage (V_{CC}) at Output Low Voltage for Various Temperatures

Figure 11. Input Offset Voltage (V_{OS}) vs. Supply Voltage (V_{CC}), V_{CM} = 1 V for Various Temperatures

Figure 12. Output Voltage (V_{OUT}) vs. Supply Voltage (V_{CC}), R_{PULLUP} = 10 kΩ

Figure 13. Supply Current vs. Supply Voltage (V_{CC}) at Output High Voltage for Various Temperatures
Figure 14. Supply Current vs. Temperature at Output High Voltage for Various Supply Voltages (VCC)

Figure 15. Input Hysteresis vs. Temperature for Various Supply Voltages (VCC), VCM = 1 V

Figure 16. Propagation Delay vs. Temperature, Low to High, VOD = 10 mV

Figure 17. Supply Current vs. Temperature at Output Low Voltage for Various Supply Voltages (VCC)

Figure 18. Input Hysteresis vs. Supply Voltage (VCC) for Various Temperatures, VCM = 1 V

Figure 19. Propagation Delay vs. Temperature, High to Low, VOD = 10 mV
6.0
5.5
5.0
4.5
4.0
3.5
3.0
2.5
2.0
1.5
1.0
0.5
0
10 100 90 80 70 60 50 40 30 20
10 100 90 80 70 60 50 40 30 20
10 100 90 80 70 60 50 40 30 20
10 100 90 80 70 60 50 40 30 20

Figure 20. Propagation Delay vs. Input Overdrive Voltage, Low to High

Figure 23. Propagation Delay vs. Input Overdrive Voltage, High to Low

Figure 21. Propagation Delay vs. Input Overdrive Voltage, Low to High, ADCMP392 Channel B

Figure 24. Propagation Delay vs. Input Overdrive Voltage, High to Low, ADCMP392 Channel B

Figure 22. Output Voltage Rise Time ($t_r$) vs. Pull-Up Resistance ($R_{PULLUP}$)

Figure 25. Output Voltage Fall Time ($t_f$) vs. Pull-Up Resistance ($R_{PULLUP}$)
THEORY OF OPERATION

BASIC COMPARATOR

In its most basic configuration, a comparator can be used to convert an analog input signal to a digital output signal (see Figure 26). The analog signal on INx+ is compared to the voltage on INx−, and the voltage at OUTx is either high or low, depending on whether INx+ is at a higher or lower potential than INx−, respectively.

![Basic Comparator and Input and Output Signals](image)

RAIL-TO-RAIL INPUT (RRI)

Using a CMOS nonRRI stage (that is, a single differential pair) limits the input voltage to approximately one gate-to-source voltage (VGS) away from one of the supply lines. Because VGS for normal operation is commonly more than 1 V, a single differential pair input stage comparator greatly restricts the allowable input voltage. This restriction can be quite limiting with low voltage supplies. To resolve this issue, RRI stages allow the input signal range to extend up to the supply voltage range. In the case of the ADCMP391/ADCMP392/ADCMP393, the inputs continue to operate 200 mV beyond the supply rails.

OPEN-DRAIN OUTPUT

The ADCMP391/ADCMP392/ADCMP393 have an open-drain output stage that requires an external resistor to pull up to the logic high voltage level when the output transistor is switched off. The pull-up resistor must be large enough to avoid excessive power dissipation, but small enough to switch logic levels reasonably quickly when the comparator output is connected to other digital circuitry. The rise time of the open-drain output depends on the pull-up resistor (RPULLUP) and load capacitor (CL) used.

The rise time can be calculated by

\[ t_R = 2.2 \frac{R_{\text{PULLUP}}}{C_L} \] (1)

POWER-UP BEHAVIOR

On power-up, when Vcc reaches 0.9 V, the ADCMP391/ADCMP392/ADCMP393 is guaranteed to assert an output low logic. When the voltage on the VCC pin exceeds UVLO, the comparator inputs take control.

CROSSOVER BIAS POINT

Rail-to-rail inputs of this type of architecture, in both op amps and comparators, have a dual front-end design. PMOS devices are inactive near the VCC rail, and NMOS devices are inactive near GND. At some predetermined point in the common-mode range, a crossover occurs. At this point, normally 0.8 V and VCC − 0.8 V, the measured offset voltages change.

COMPARATOR HYSTERESIS

In noisy environments, or when the differential input amplitudes are relatively small or slow moving, adding hysteresis (VHYS) to the comparator is often desirable. The transfer function for a comparator with hysteresis is shown in Figure 27. As the input voltage approaches the threshold (0 V in Figure 27) from below the threshold region in a positive direction, the comparator switches from low to high when the input crosses +VHYS/2. The new switch threshold becomes −VHYS/2. The comparator remains in the high state until the −VHYS/2 threshold is crossed from below the threshold region in a negative direction. In this manner, noise or feedback output signals centered on the 0 V input cannot cause the comparator to switch states unless it exceeds the region bounded by ±VHYS/2.

![Comparator Hysteresis Transfer Function](image)
TYPICAL APPLICATIONS

ADDING HYSTERESIS

To add hysteresis, see Figure 28; two resistors are used to create different switching thresholds, depending on whether the input signal is increasing or decreasing in magnitude. When the input voltage increases, the threshold is above $V_{REF}$, and when the input voltage decreases, the threshold is below $V_{REF}$.

![Figure 28. Noninverting Comparator Configuration with Hysteresis](image)

The upper input threshold level is given by

$$V_{IN,H} = \frac{V_{REF}(R1 + R2)}{R2}$$

(2)

Assuming $R_{LOAD} >> R2$, $R_{PULLUP}$.

The lower input threshold level is given by

$$V_{IN,LO} = \frac{V_{REF}(R1 + R2 + R_{PULLUP}) - V_{CL}R1}{R2 + R_{PULLUP}}$$

(3)

The hysteresis is the difference between these voltages levels.

$$V_{HYS} = \frac{V_{REF}R1R_{PULL-UP} + V_{CL}R1R2}{R2(R2 + R_{PULL-UP})}$$

(4)

WINDOW COMPARATOR FOR POSITIVE VOLTAGE MONITORING

When monitoring a positive supply, the desired nominal operating voltage for monitoring is denoted by $V_M$, $I_M$ is the nominal current through the resistor divider, $V_{OV}$ is the overvoltage trip point, and $V_{UV}$ is the undervoltage trip point.

![Figure 29. Positive Undervoltage/Overvoltage Monitoring Configuration](image)

Figure 29 illustrates the positive voltage monitoring input connection. Three external resistors, $R_X$, $R_Y$, and $R_Z$, divide the positive voltage for monitoring, $V_M$, into the high-side voltage, $V_{PH}$, and the low-side voltage, $V_{PL}$. The high-side voltage is connected to the INA+ pin and the low-side voltage is connected to the INB− pin.

To trigger an overvoltage condition, the low-side voltage (in this case, $V_{PL}$) must exceed the $V_{REF}$ threshold on the INB+ pin. Calculate the low-side voltage, $V_{PL}$, by the following:

$$V_{PL} = V_{REF} = V_{OV}\left(\frac{R_Z}{R_X + R_Y + R_Z}\right)$$

(5)

In addition,

$$R_X + R_Y + R_Z = V_M/I_M$$

(6)

Therefore, $R_Z$, which sets the desired trip point for the overvoltage monitor, is calculated as

$$R_Z = \left(\frac{V_{REF}}{V_{OV}}\right)\left(\frac{V_M}{I_M}\right)$$

(7)

To trigger the undervoltage condition, the high-side voltage, $V_{PH}$, must be less than the $V_{REF}$ threshold on the INA− pin. The high-side voltage, $V_{PH}$, is calculated by

$$V_{PH} = V_{REF} = V_{UV}\left(\frac{R_Y + R_Z}{R_X + R_Y + R_Z}\right)$$

(8)

Because $R_Z$ is already known, $R_Y$ can be expressed as

$$R_Y = \left(\frac{V_{REF}}{V_{UV}}\right)\left(\frac{V_M}{I_M}\right) - R_Z$$

(9)

When $R_Y$ and $R_Z$ are known, $R_X$ can be calculated by

$$R_X = (V_M/I_M) - R_Y - R_Z$$

(10)

If $V_M$, $I_M$, $V_{OV}$, or $V_{UV}$ changes, each step must be recalculated.
WINDOW COMPARATOR FOR NEGATIVE VOLTAGE MONITORING

Figure 30 shows the circuit configuration for negative supply voltage monitoring. To monitor a negative voltage, a reference voltage is required to connect to the end node of the voltage divider circuit, in this case, \( V_{\text{REF}} \).

Because \( R_z \) is already known, \( R_x \) can be expressed as follows:

\[
R_x = \frac{V_{\text{REF}} (V_M - V_{\text{REF}})}{I_M (V_{\text{REF}} - V_U)} - R_z
\]

(15)

When \( R_x \) and \( R_z \) are known, \( R_y \) is then calculated by

\[
R_y = \frac{(V_M - V_{\text{REF}})}{I_M} - R_y - R_z
\]

(16)

PROGRAMMABLE SEQUENCING CONTROL CIRCUIT

The circuit shown in Figure 31 is used to control the power supply sequencing. The delay is set by the combination of the pull-up resistor (\( R_{\text{PULLUP}} \)), the load capacitor (\( C_L \)), and the resistor divider network.

Figure 32 shows a simplified block diagram for the programmable sequencing control circuit. The application delays the enable signal, EN, of the external regulators (LDO x) in a linear order when the open-drain signal (SEQ) changes from low to high impedance.

The ADCMP391/ADCMP392/ADCMP393 have a defined output state during startup, which prevents any regulator from turning on if \( V_{\text{CC}} \) is still below the UVLO threshold.
When the SEQ signal changes from low to high impedance, the load capacitor, \(C_L\), starts to charge. The time it takes to charge the load capacitor to the pull-up voltage (in this case, \(V_{REF}\) or \(V_{CC}\)) is the maximum delay programmable in the circuit. It is recommended to have the threshold within 10% to 90% of the pull-up voltage. Calculate the maximum allowable delay by

\[
\tau_{MAX} = \tau_R = 2.2 \frac{R_{PULLUP} \cdot C_L}{I_{DIV}}
\]

The delay of each output is changed by changing the threshold voltage, \(V_1\) to \(V_4\), when the comparator changes its output state. To calculate the voltage thresholds for the comparator, use the following formulas:

\[
V_1 = V_{REF} \left(1 - e^{-\frac{\tau_1}{R_{PULLUP} \cdot C_L}}\right)
\]

\[
V_2 = V_{REF} \left(1 - e^{-\frac{\tau_2}{R_{PULLUP} \cdot C_L}}\right)
\]

\[
V_3 = V_{REF} \left(1 - e^{-\frac{\tau_3}{R_{PULLUP} \cdot C_L}}\right)
\]

\[
V_4 = V_{REF} \left(1 - e^{-\frac{\tau_4}{R_{PULLUP} \cdot C_L}}\right)
\]

The threshold voltages can come from a voltage reference or a voltage divider circuit, as shown in Figure 31.

---

Figure 33. Programmable Sequencing Control Circuit Timing Diagram

First, determine the allowable current, \(I_{DIV}\), flowing through the resistor divider. After the value for \(I_{DIV}\) is determined, calculate \(R_1\), \(R_2\), \(R_3\), \(R_4\), and \(R_5\) using the following formulas:

\[
R_{DIV} = \frac{V_{REF}}{I_{DIV}} = R_1 + R_2 + R_3 + R_4 + R_5
\]

\[
R_1 = \frac{V_1 \cdot R_{DIV}}{V_{REF}}
\]

\[
R_2 = \frac{V_2 \cdot R_{DIV}}{V_{REF}} - R_1
\]

\[
R_3 = \frac{V_3 \cdot R_{DIV}}{V_{REF}} - R_1 - R_2
\]

\[
R_4 = \frac{V_4 \cdot R_{DIV}}{V_{REF}} - R_1 - R_2 - R_3
\]

\[
R_5 = R_{DIV} - R_1 - R_2 - R_3 - R_4
\]

To create a mirrored voltage sequence, add a resistor, \(R_{MIRROR}\), between the pull-up resistor (\(R_{PULLUP}\)) and the load capacitor (\(C_L\)) as shown in Figure 34.

---

Figure 34. Circuit Configuration for a Mirrored Voltage Sequencer

Figure 34 shows the circuit configuration for a mirrored voltage sequencer. When SEQ changes from low to high impedance, the response is similar to Figure 33. When SEQ changes from high impedance to low, the load capacitor (\(C_L\)) starts to discharge at a rate set by \(R_{MIRROR}\). The delay of each comparator is dependent on the threshold voltage previously set for \(\tau_1\) to \(\tau_4\). The result is a mirrored power-down sequence.
The timing diagram for the mirrored voltage sequencer is shown in Figure 35.

Equation 18 through Equation 21 must account for the additional resistance, $R_{\text{mirror}}$, in the calculations of the voltage thresholds. To calculate these new thresholds, see Equation 28 through Equation 31.

$$V_1 = V_{\text{REF}} \left(1 - e^{-R_{\text{pullup}} + R_{\text{mirror}} V_{\text{CLR}}^{-1} t_1} \right)$$  \hspace{1cm} (28)

$$V_2 = V_{\text{REF}} \left(1 - e^{-R_{\text{pullup}} + R_{\text{mirror}} V_{\text{CLR}}^{-1} t_2} \right)$$  \hspace{1cm} (29)

$$V_3 = V_{\text{REF}} \left(1 - e^{-R_{\text{pullup}} + R_{\text{mirror}} V_{\text{CLR}}^{-1} t_3} \right)$$  \hspace{1cm} (30)

$$V_4 = V_{\text{REF}} \left(1 - e^{-R_{\text{pullup}} + R_{\text{mirror}} V_{\text{CLR}}^{-1} t_4} \right)$$  \hspace{1cm} (31)

$R_{\text{mirror}}$ provides the mirrored delay by prolonging the discharge time of the capacitor. The mirrored voltage sequencer uses the same threshold in Equation 28 to Equation 31 in a decreasing order. To calculate the exact value of the mirrored delay time, see Equation 32 through Equation 35.

$$t_5 = -R_{\text{mirror}} C_L \ln \left( \frac{V_4}{V_{\text{REF}}} \right)$$  \hspace{1cm} (32)

$$t_6 = -R_{\text{mirror}} C_L \ln \left( \frac{V_3}{V_{\text{REF}}} \right)$$  \hspace{1cm} (33)

$$t_7 = -R_{\text{mirror}} C_L \ln \left( \frac{V_2}{V_{\text{REF}}} \right)$$  \hspace{1cm} (34)

$$t_8 = -R_{\text{mirror}} C_L \ln \left( \frac{V_1}{V_{\text{REF}}} \right)$$  \hspace{1cm} (35)

**MIRRORED VOLTAGE SEQUENCER EXAMPLE**

To illustrate how the mirrored voltage sequencer works, see Figure 32 and then consider a system that uses a $V_{\text{REF}}$ of 1 V and requires a delay of 50 ms when SEQ changes from low to high impedance, and between each regulator when turning on. These considerations require a rise time of at least 200 ms for the pull-up resistor ($R_{\text{pullup}}$) and the load capacitor ($C_L$). The sum of the resistance of $R_{\text{mirror}}$ and $R_{\text{pullup}}$ must be large enough to charge the capacitor longer than the minimum required delay. For a symmetrical mirrored power-down sequence, the value of $R_{\text{mirror}}$ must be much larger than $R_{\text{pullup}}$. A 10 kΩ $R_{\text{pullup}}$ value limits the pull-down current to 100 µA while giving a reasonable value for $R_{\text{mirror}}$. A typical 1 µF capacitor together with a 150 kΩ $R_{\text{mirror}}$ value gives a value of

$$I_{\text{MAX}} = 2.2((160 \times 10^3) \times (1 \times 10^{-6})) = 351 \text{ ms}$$  \hspace{1cm} (36)

The threshold voltage required by each comparator is set by Equation 28 to Equation 31. For example,

$$V_1 = V_{\text{REF}} \left(1 - e^{-6101310160 \times 10^{-9} t_1} \right)$$

where $V_1 = 268.38 \text{ mV}$.

Therefore, $V_2 = 464.74 \text{ mV}$, $V_3 = 608.39 \text{ mV}$, and $V_4 = 713.5 \text{ mV}$.

Next, consider 10 µA as the maximum current ($I_{\text{DIV}}$) flowing through the resistor divider network. This current gives the total resistance of the divider network ($R_{\text{DIV}}$) and the individual resistor values using Equation 22 to Equation 27, resulting in the following:

- $R_{\text{DIV}} = 100 \text{ kΩ}$
- $R_1 = 26.84 \text{ kΩ} \approx 26.7 \text{ kΩ}$
- $R_2 = 19.64 \text{ kΩ} \approx 19.6 \text{ kΩ}$
- $R_3 = 14.37 \text{ kΩ} \approx 14.3 \text{ kΩ}$
- $R_4 = 10.51 \text{ kΩ} \approx 10.5 \text{ kΩ}$
- $R_5 = 28.65 \text{ kΩ} \approx 28.7 \text{ kΩ}$
Resistor values from the calculation are nonindustry standard, using industry standard resistor values resulted in a new \( R_{DIV} \) value of 99.8 kΩ. Due to the discrepancy of the calculated resistor value to the industry standard value, the threshold of each comparator also changed. Calculate the new threshold values by using a simple voltage divider formula:

\[
V_1 = \frac{V_{REF}R_1}{R_{DIV}}
\]

where \( V_1 = \frac{1}{99.8 \text{ kΩ}} \quad 26.7 \text{ kΩ} = 267.54 \text{ mV} \).

Therefore, \( V_2 = 463.93 \text{ mV}, V_3 = 607.21 \text{ mV}, \) and \( V_4 = 712.42 \text{ mV} \).

Because the threshold of each comparator has changed, the time when each comparator changes its output has also changed. Calculate the new delay values for each comparator by using the following equation:

\[
t_j = -C_L \left( R_{PULLUP} + R_{MIRROR} \right) \ln \left( 1 - \frac{V_1}{V_{REF}} \right)
\]

where \( t_1 = -1 \mu F(10 \text{ kΩ} + 150 \text{ kΩ}) \ln \left( 1 - \frac{267.54 \text{ mV}}{1} \right) = 49.81 \text{ ms} \).

Therefore, \( t_2 = 99.78 \text{ ms}, t_3 = 149.52 \text{ ms}, \) and \( t_4 = 199.4 \text{ ms} \).

To calculate \( t_5 \) through \( t_8 \), use Equation 32 to Equation 35:

\[
t_j = -R_{MIRROR} C_j \ln \left( \frac{V_4}{V_{REF}} \right)
\]

where \( t_5 = -150 \text{ kΩ} \times 1 \mu F \times \ln \left( \frac{712.42 \text{ mV}}{1} \right) = 50.86 \text{ ms} \).

Therefore, \( t_6 = 74.83 \text{ ms}, t_7 = 115.2 \text{ ms}, \) and \( t_8 = 197.78 \text{ ms} \).

### Threshold and Timeout Programmable Voltage Supervisor

Figure 36 shows a circuit configuration for a programmable threshold and timeout circuit. The timeout, \( t_{RESET} \), defines the duration that the input voltage (\( V_{IN} \)) must be kept above the threshold voltage to toggle the \( \text{RESET} \) signal, preventing the device from operating when \( V_{IN} \) is not stable. If \( V_{IN} \) falls below the threshold voltage, the \( \text{RESET} \) signal toggles quickly.

During startup, the ADCMP391/ADCMP392/ADCMP393 guarantee a low output state when \( V_{CC} \) is still below the UVLO threshold, preventing the voltage supervisor from toggling.

When \( V_{IN} \) reaches the threshold set by the resistor divider (R1 and R2) and \( V_{REF} \), OUT1 changes from low to high and starts to charge the timeout capacitor (\( C_T \)). If \( V_{IN} \) is kept above the threshold voltage and the voltage in \( C_T \) reaches \( V_{REF} \), OUT2 toggles. If \( V_{IN} \) falls below the threshold voltage while \( C_T \) is charging, the timeout capacitor quickly discharges, preventing OUT2 from toggling while \( V_{IN} \) is not stable.

In the condition that \( V_{IN} \) is tied to \( V_{CC} \), the circuit operates when \( V_{CC} \) is more than the minimum operating voltage.

The threshold voltage \( (V_{TH}) \) is configured by changing the resistor divider or \( V_{REF} \). Calculate the threshold voltage by

\[
V_{TH} = V_{REF} \left( 1 + \frac{R_1}{R_2} \right)
\]

Timeout is adjusted by changing the values of the pull-up resistor or the timeout capacitor. To set the timeout value, determine the allowable current flowing through \( R_{PULLUP} \), \( I_{PULLUP} \). When \( I_{PULLUP} \) is known, calculate \( R_{PULLUP} \) and \( C_T \) by the following formulas:

\[
R_{PULLUP} = \frac{V_{CC}}{I_{PULLUP}}
\]

\[
C_T = \frac{-t_{RESET}}{R_{PULLUP} \ln \left( 1 - \frac{V_{REF}}{V_{CC}} \right)}
\]
OUTLINE DIMENSIONS

Figure 38. 8-Lead Standard Small Outline Package [SOIC_N] Narrow Body (R-8)
Dimensions shown in millimeters and (inches)

Figure 39. 14-Lead Standard Small Outline Package [SOIC_N] Narrow Body (R-14)
Dimensions shown in millimeters and (inches)
### ORDERING GUIDE

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<th>Model</th>
<th>Temperature Range</th>
<th>Package Description</th>
<th>Package Option</th>
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1 Z = RoHS Compliant Part.